



Surface Mount Super fast Recovery Rectifier

Reverse Voltage – 800 V

Forward Current – 5.0 A

FEATURES

- High current capability
- Low forward voltage drop
- Low power loss, high efficiency
- High surge capability
- High temperature soldering guaranteed
- Mounting position: any

TO-251(I-PAK)



TO-252(D-PAK)



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified

CHARACTERISTICS	TO-251	SF508VY	Units
	TO-252	SF508DY	
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	800	V
Maximum RMS voltage	V_{RMS}	560	V
Maximum DC Blocking Voltage	V_{DC}	800	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	5.0	A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	150	A
Max Instantaneous Forward Voltage at 5 A	V_F	2.30	V
Maximum DC Reverse Current $T_a = 25^\circ\text{C}$ at Rated DC Reverse Voltage $T_a = 125^\circ\text{C}$	I_R	1 300	uA
Typical Junction Capacitance $f=1\text{MHz}, 4\text{V DC}$	C_j	60	pF
Typical Thermal Resistance ⁽¹⁾	$R_{\theta JA}$	50	°C/W
Maximum Reverse Recovery Time ⁽²⁾	t_{rr}	35	ns
Operating Junction Temperature Range	T_j	-55 ~ +150	°C
Storage Temperature Range	T_{stg}	-55 ~ +150	°C

(1) P.C.B. mounted with 10cm x 10cm x 1mm copper pad areas.

(2) Measured with $I_F = 0.5\text{ A}$, $I_R = 1\text{ A}$, $I_{rr} = 0.25\text{ A}$.



Fig.1 Maximum Average Forward Current Rating

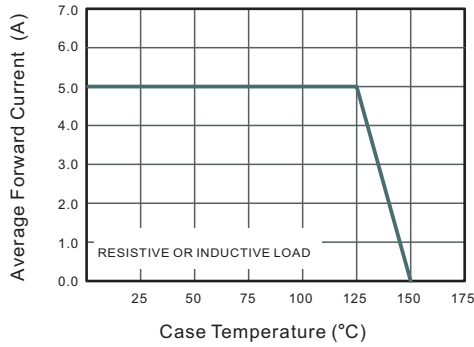


Fig.2 Typical Reverse Characteristics

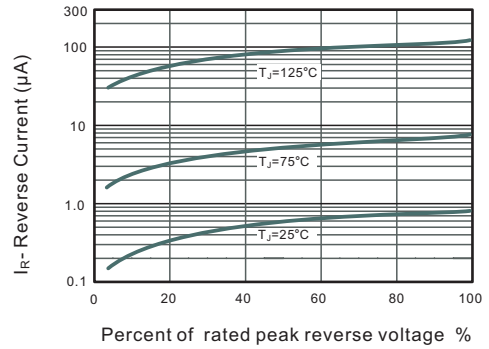


Fig.3 Typical Forward Characteristics

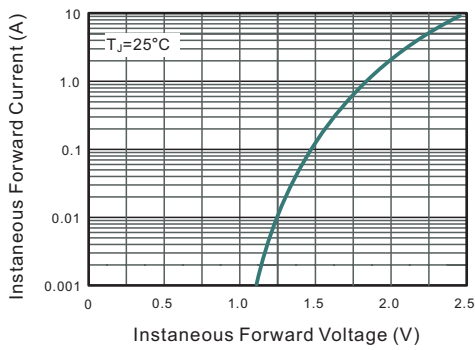


Fig.4 Typical Junction Capacitance

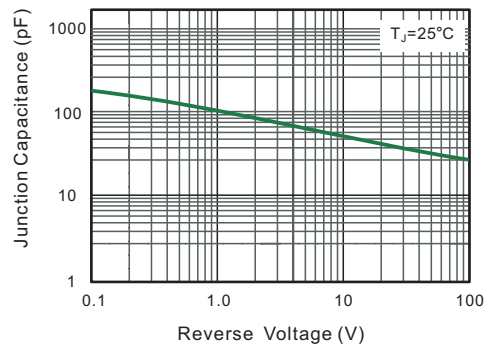


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

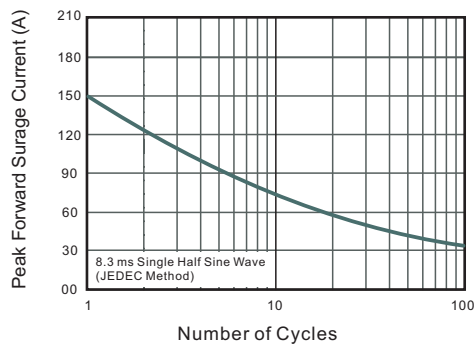
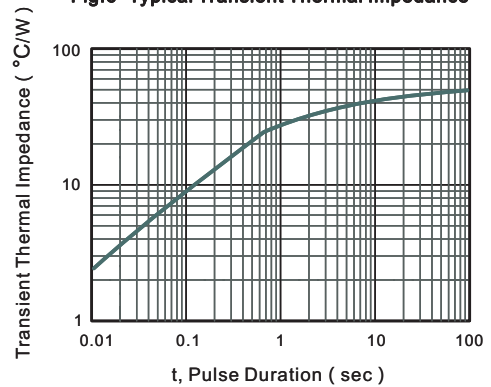
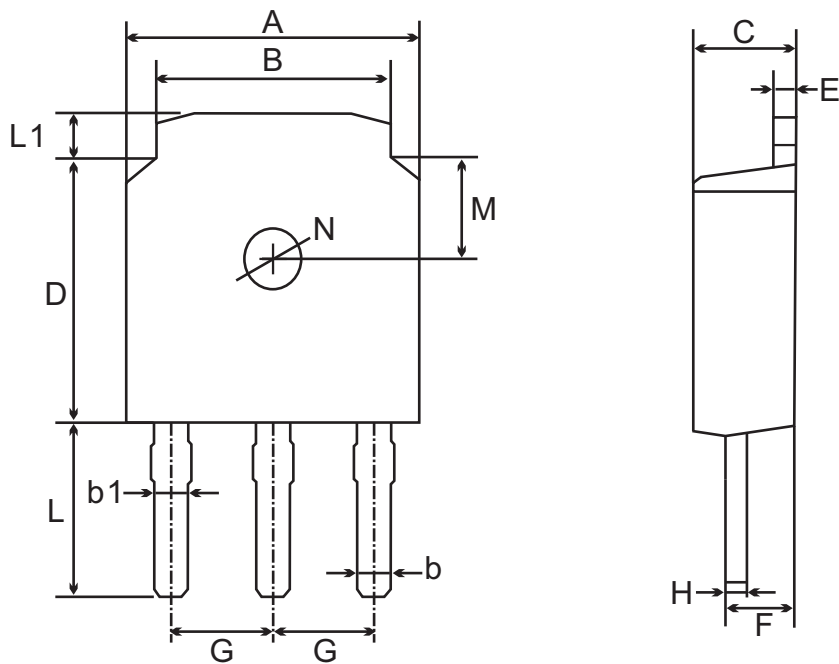


Fig.6- Typical Transient Thermal Impedance





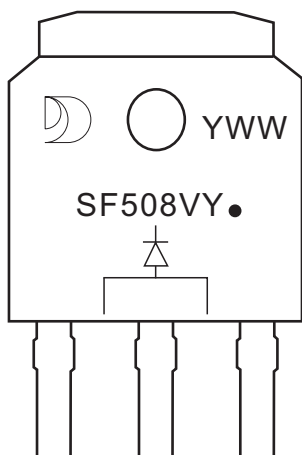
TO-251(I-PAK) Package Outline Dimensions



TO-251(I-PAK) mechanical data

UNIT		A	B	b	b1	C	D	E	F	G	H	L	L1	M	N
mm	max	6.7	5.5	0.8	0.9	2.5	6.3	0.6	1.8	2.29 TYPICAL	0.55	4.3	1.2	1.8 TYPICAL	1.3 TYPICAL
	min	6.3	5.1	0.3	0.76	2.1	5.9	0.4	1.3		0.45	3.9	0.8		
mil	max	264	217	31	35	98	248	24	71	90 TYPICAL	22	169	47	71 TYPICAL	51 TYPICAL
	min	248	201	12	30	83	232	16	51		18	154	31		

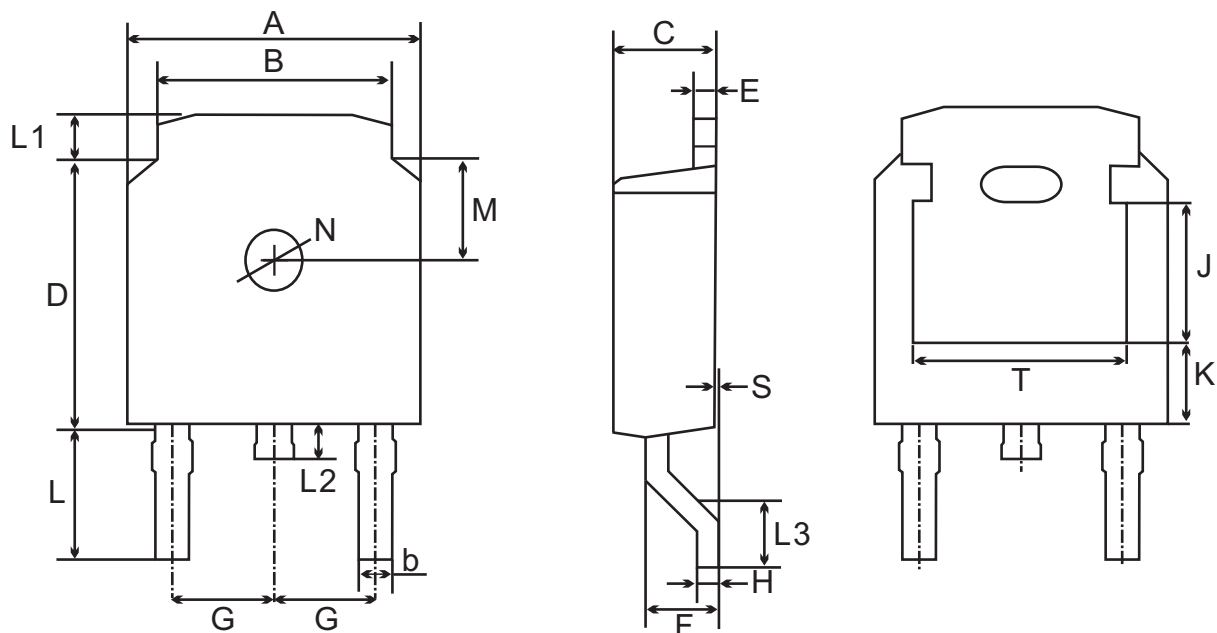
MARKING DIAGRAM



YWW: Date Code
Y: Years(0~9)
WW: Week
SF508VY: Product name
(NOTE: The weekly code is based on the actual number of weeks in the calendar year.)



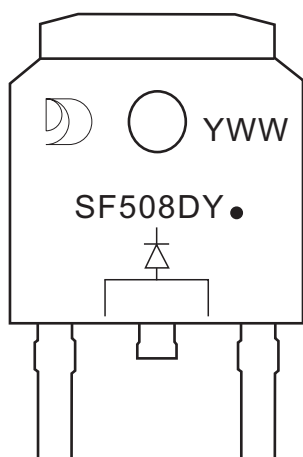
TO-252(D-PAK) Package Outline Dimensions



TO-252(D-PAK) mechanical data

UNIT	A	B	b	C	D	E	F	G	H	L	L1	L2	L3	S	M	N	J	K	T	
mm	max	6.7	5.5	0.8	2.5	6.3	0.6	1.8	2.29 TYPICAL	0.55	3.1	1.2	1.0	1.75	0.1	1.8 TYPICAL	1.3	3.16	1.80	4.83
	min	6.3	5.1	0.3	2.1	5.9	0.4	1.3		0.45	2.7	0.8	0.6	1.40	0.0		ref.	ref.	ref.	
mil	max	264	217	31	98	248	24	71	90 TYPICAL	22	122	47	39	69	4	71 TYPICAL	51	124	71	190
	min	248	201	12	83	232	16	51		18	106	31	24	55	0		ref.	ref.	ref.	

MARKING DIAGRAM



YWW: Date Code
Y:Years(0~9)
WW:Week
SF508DY: Product name
(NOTE: The weekly code is based on the actual number of weeks in the calendar year.)



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